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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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FDB0260N1007L N-Channel PowerTrench[®] MOSFET 100 V, 200 A, 2.6 m Ω

Features

- Max r_{DS(on)} = 2.6 mΩ at V_{GS} = 10 V, I_D = 27 A
- Fast Switching Speed
- Low Gate Charge
- \blacksquare High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been especially tailored to minimize the on-state resistance while maintaining superior ruggedness and switching performance for industrial applications.

Applications

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch



MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Paramete	er		Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25°C	(Note 5)	200		
	-Continuous	T _C = 100°C	(Note 5)	140	Α	
	-Pulsed		(Note 4)	1100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	912	mJ	
P _D	Power Dissipation	T _C = 25°C		250	w	
	Power Dissipation	T _A = 25°C	(Note 1a)	3.8	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	
Thermal Ch	naracteristics					
$R_{\theta JC}$	Thermal Resistance, Junction to Case		(Note 1)	0.6		

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	0.6	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB0260N1007L	FDB0260N1007L	D2-PAK-7L	330 mm	24 mm	800 units

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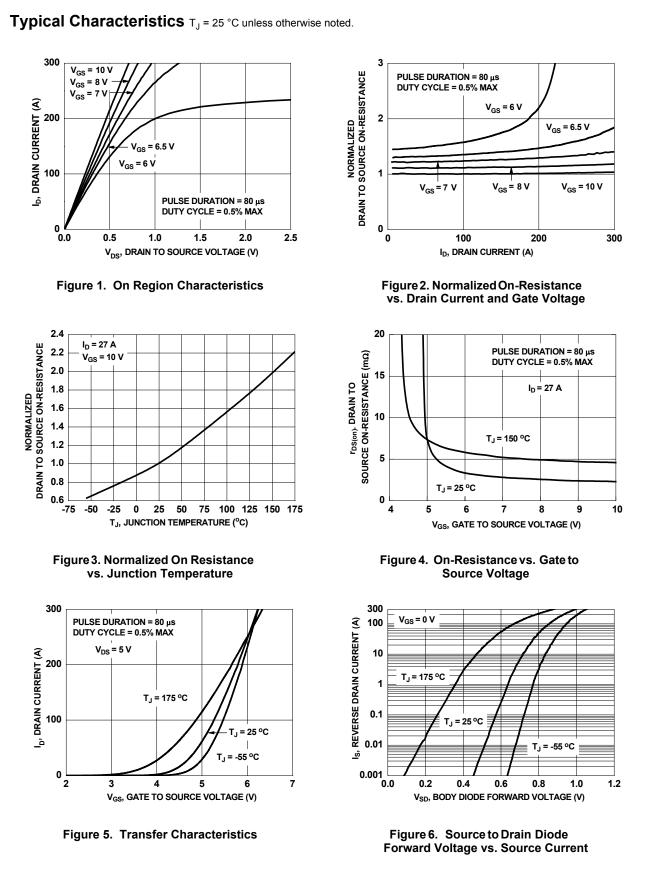
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		53		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	cteristics (Note 2)					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	2.8	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		-13		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 27 A		2.3	2.6	mO
		V_{GS} = 10 V, I _D = 27 A, T _J = 150°C		4.5	6.6	— mΩ
9 _{FS}	Forward Transconductance	V_{DS} = 10 V, I _D = 27 A		59		S
-	Characteristics		1		1	1
C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		6101	8545	pF
C _{oss}	Output Capacitance			1343	1885	pF
C _{rss}	Reverse Transfer Capacitance			46	65	pF
R _g	Gate Resistance			2.7		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			30	48	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 27 A,		29	46	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		51	81	ns
t _f	Fall Time			19	34	ns
Qg	Total Gate Charge	V _{DD} = 50 V, I _D = 27 A,		84	118	nC
Q _{gs}	Gate to Source Gate Charge	$V_{GS} = 10 V$		25		nC
Q _{gd}	Gate to Drain "Miller" Charge			17		nC
Drain-Sou	urce Diode Characteristics					
I _S	Maximum Continuous Drain to Source Diode Forward Current				200	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current				1100	Α
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 27 A$ (Note 2)		0.8	1.2	V
t _{rr}	Reverse Recovery Time	— I _F = 27 A, di/dt = 100 A/μs		75	120	ns
Q _{rr}	Reverse Recovery Charge	$I_F = 27 A$, di/dt = 100 A/µs		97	155	nC

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

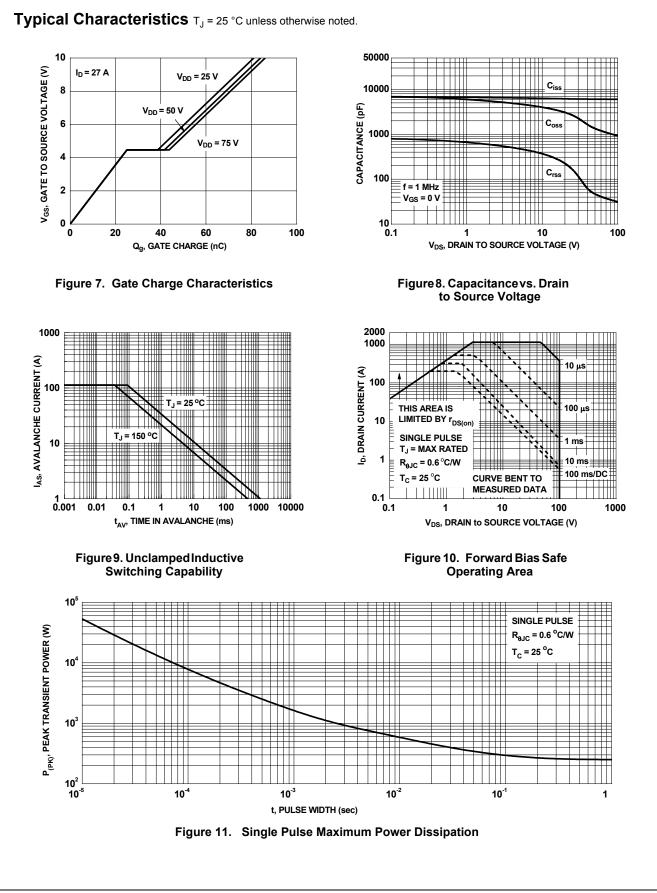
3. E_{AS} of 912 is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 78 A, V_{DD} = 10 V, V_{GS} = 90 V. 100% test at L = 0.1 mH, I_{AS} = 113 A.

4. Pulsed Id please refer to Figure "Forward Bias Safe Operating Area" for more details.

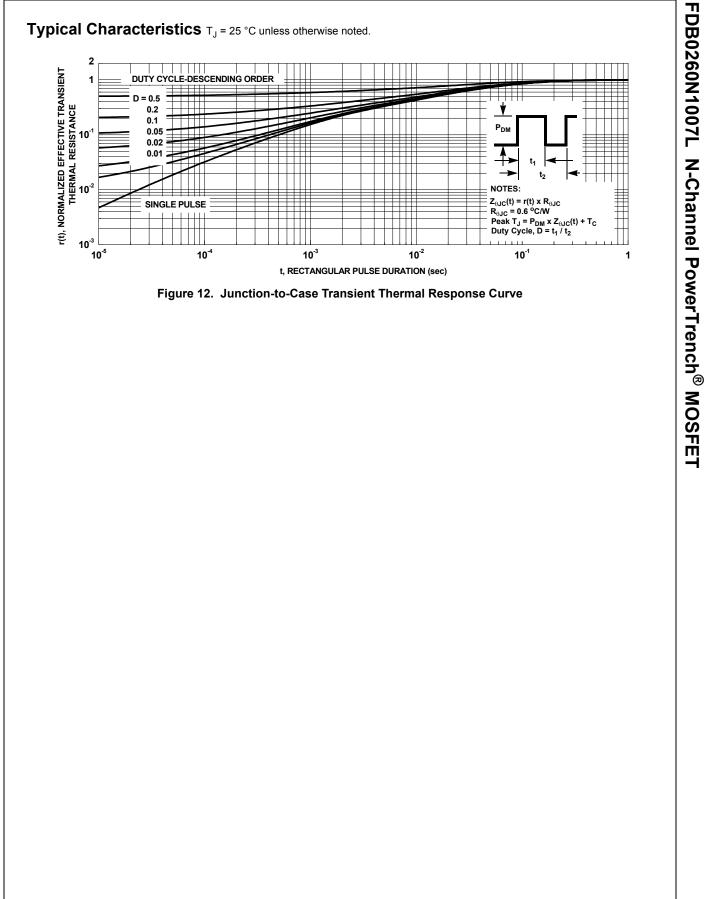
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

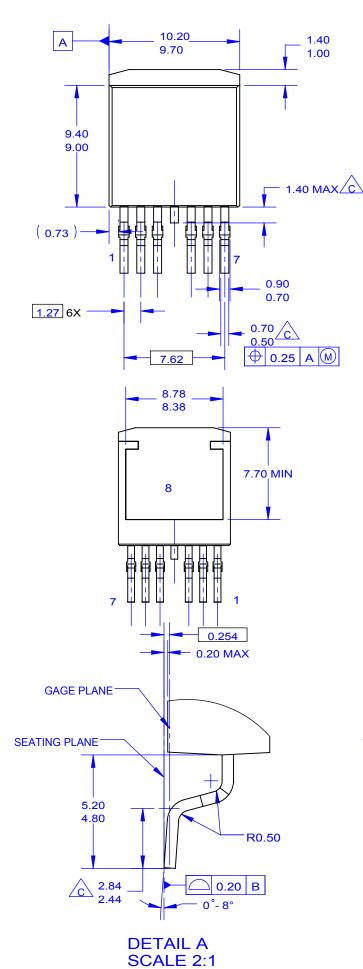


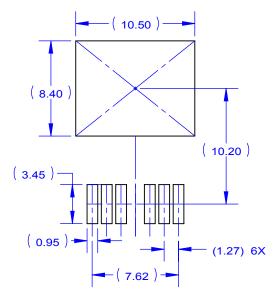
FDB0260N1007L N-Channel PowerTrench[®] MOSFET



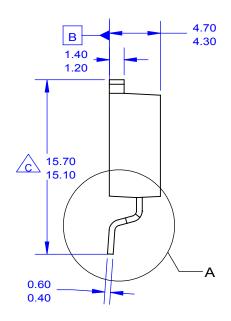
FDB0260N1007L N-Channel PowerTrench[®] MOSFET







LAND PATTERN RECOMMENDATION



NOTES:

- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED.
 B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C OUT OF JEDEC STANDARD VALUE. D. DIMENSION AND TOLERANCE AS PER ASME
 - Y14.5-1994. E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
 - F. LAND PATTERN RECOMMENDATION PER IPC. TO127P1524X465-8N.
 - G. DRAWING FILE NAME: TO263A07REV5.

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